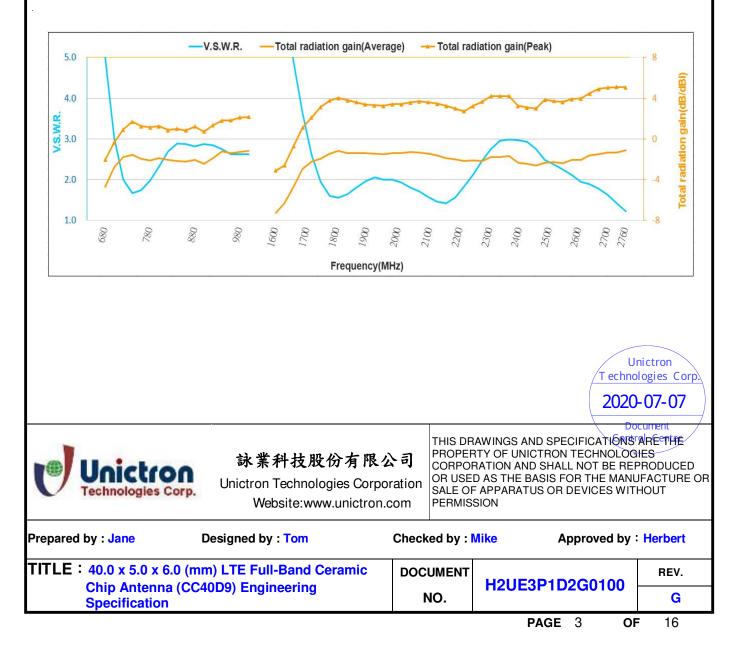
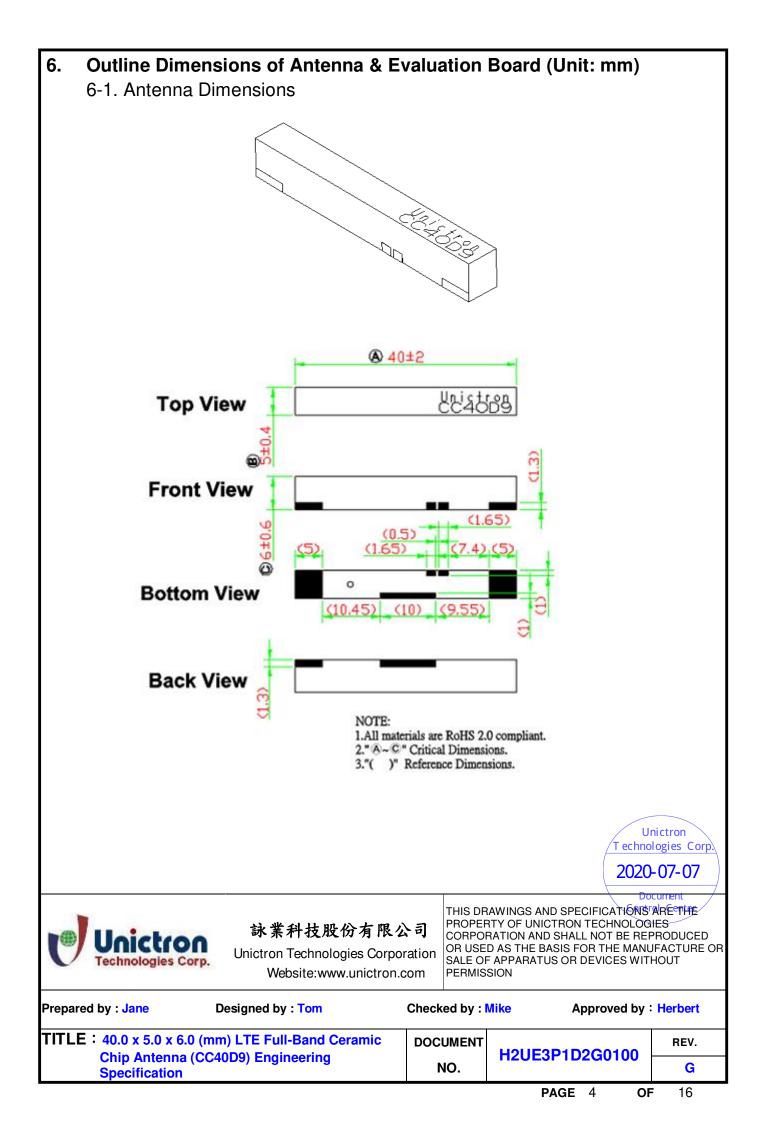


5-2. Electrical Specifications (with 120 x 45 mm² Evaluation Board) 5-2-1. Electrical Table **Characteristics Specifications** 40.0 x 5.0 x 6.0 Outline Dimension (mm) Ground Plane Dimension (mm) 107 x 45 698 ~ 798 1710 ~ 2170 2490 ~ 2690 Working Frequency (MHz) 824 ~ 960 $2300 \sim 2400$ Peak Gain (dBi) (typical)** 1.4 0.7 3.2 3.8 4.2 65 Efficiency (%) (typical)** 69 57 67 62 VSWR (@ center frequency)* <3.5:1 Characteristic Impedance (Ω) 50 Polarization Linear Polarization

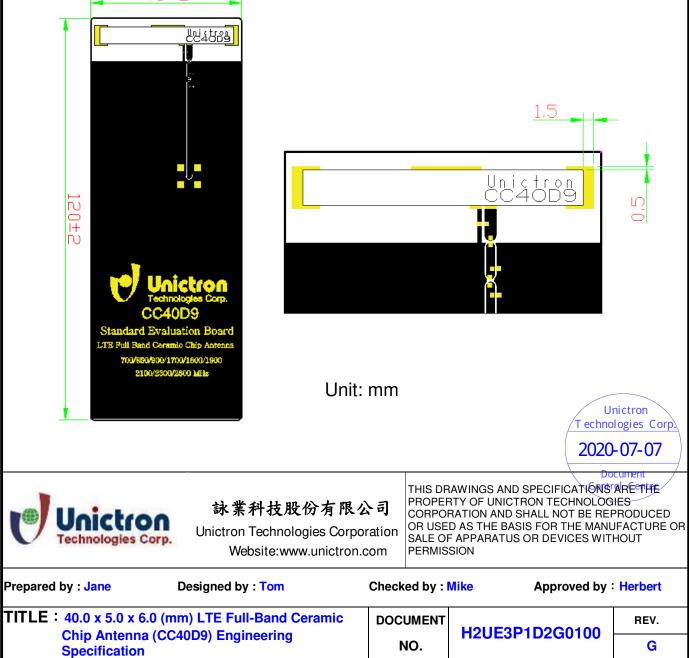
*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board. **A typical value is for reference only, not guaranteed.

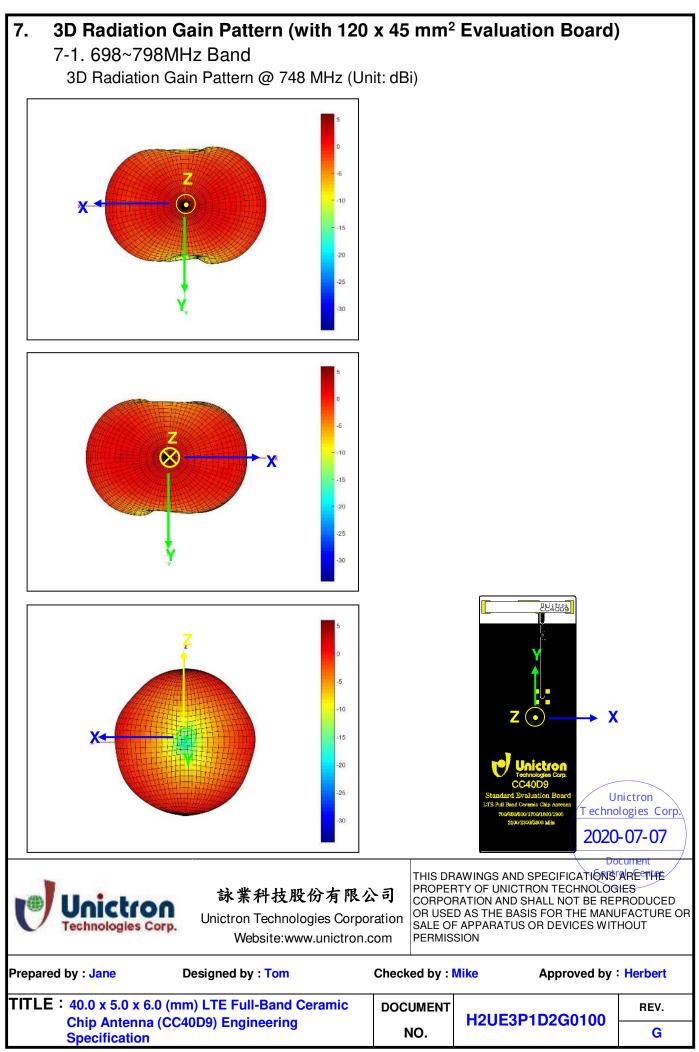
5-2-2. V.S.W.R. and Total Radiation Gain vs. Frequency



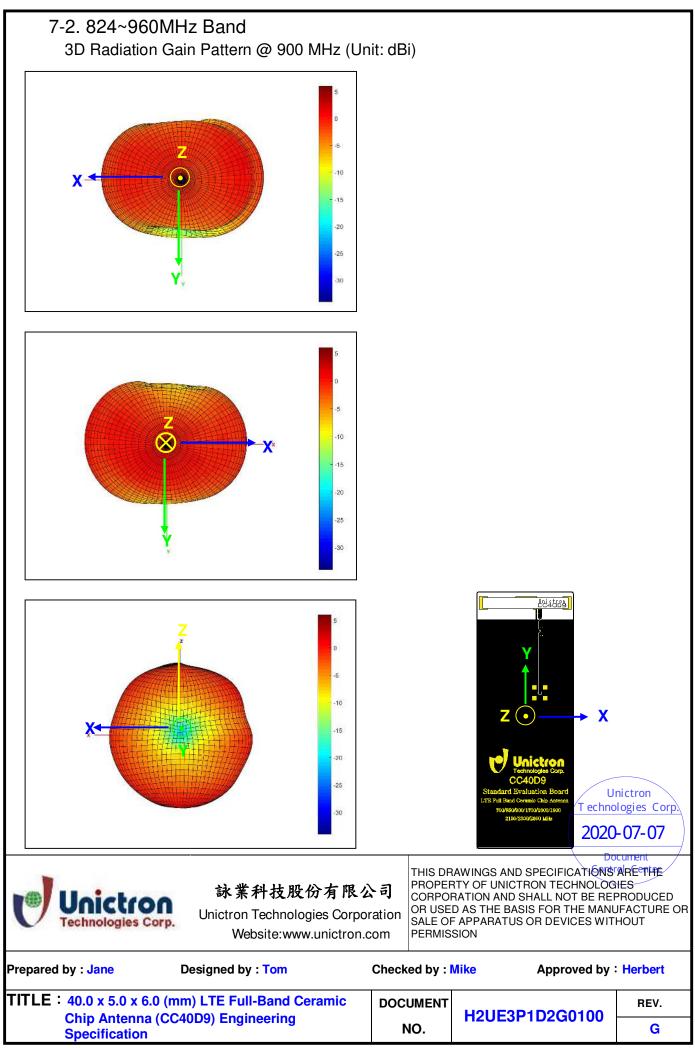


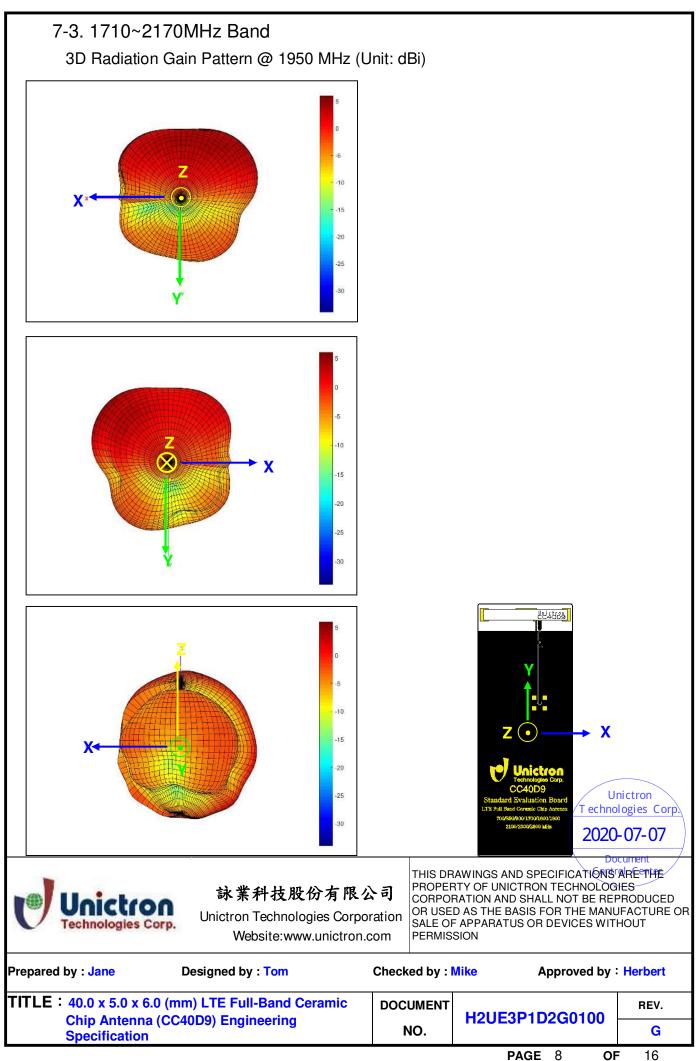
Bottom ViewPIN123~5Soldering PadTuning/GroundSignalN/C
Soldering Pad Tuning/Ground Signal N/C
Soldering Pad Tuning/Ground Signal N/C Evaluation Board & Antenna's Location
valuation Board & Antenna's Location

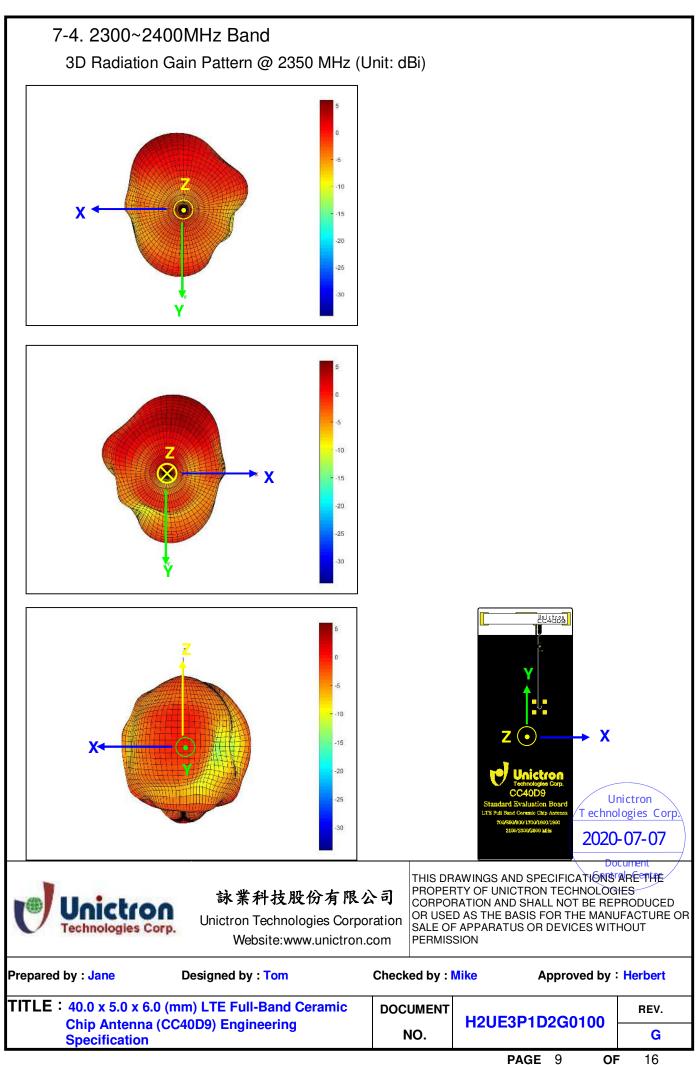


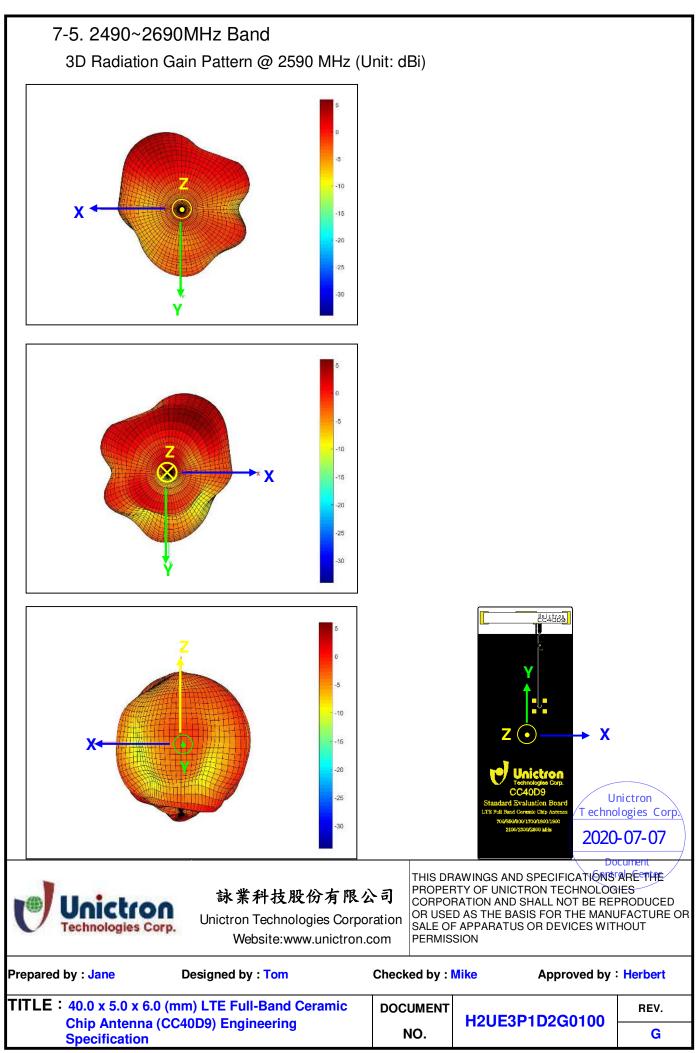


OF 16



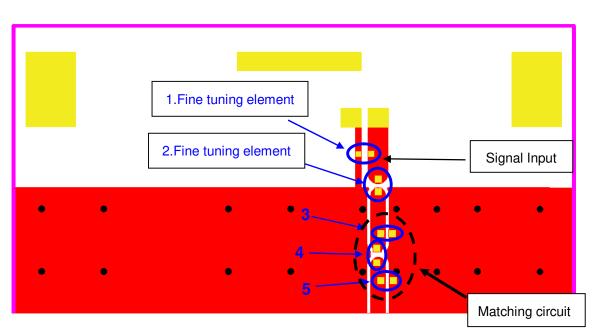






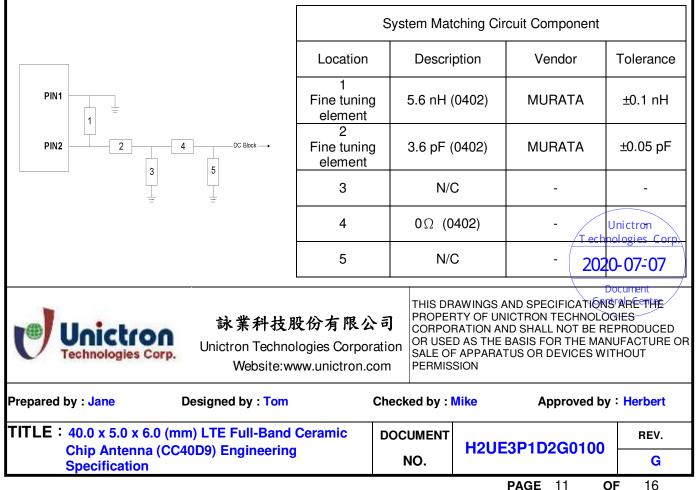
8. Frequency tuning

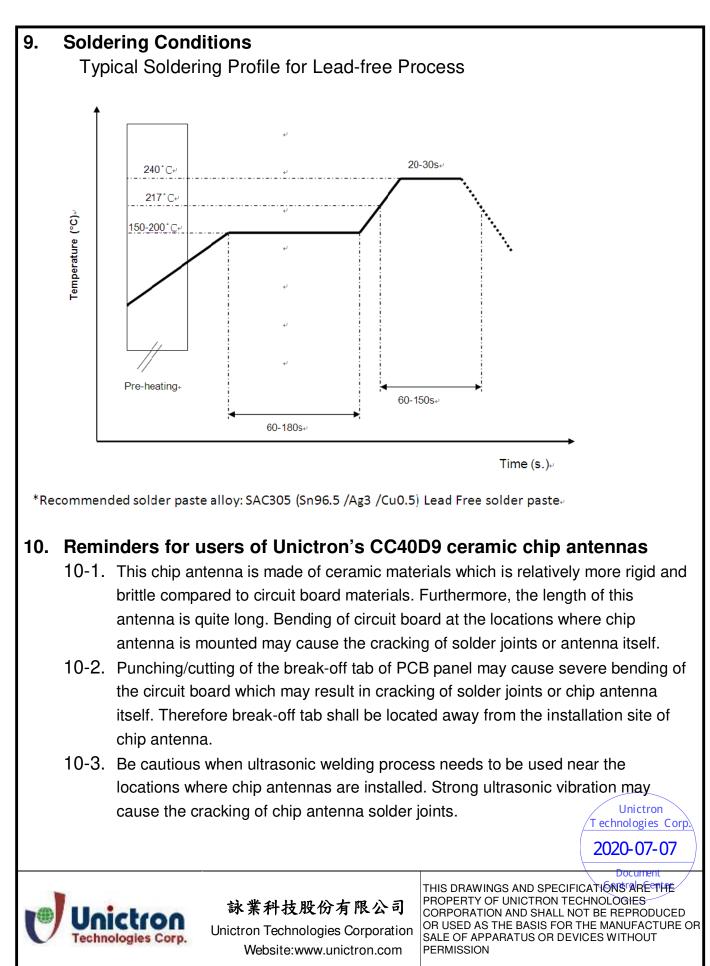
8-1. Chip antenna tuning scenario :



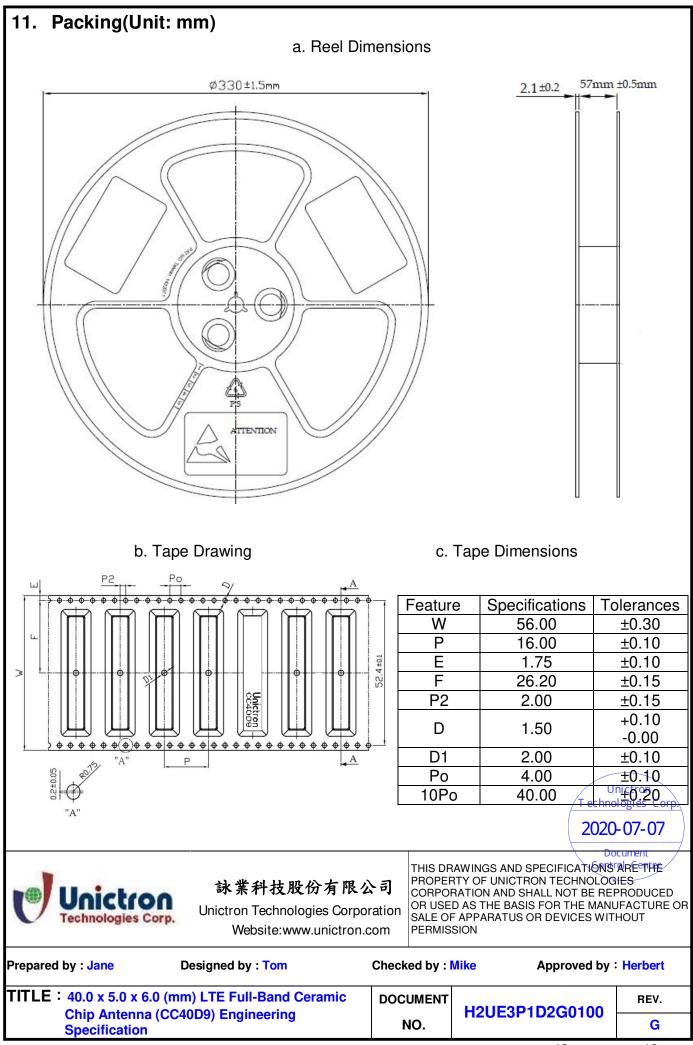
8-2. Matching circuit :

With the following recommended values of matching and tuning components, the covering frequencies will be about 698~960 MHz & 1710~2690 MHz at our standard 120 x 45 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.





Prepared by : Jane	Designed by : Tom	Checked by :	Mike Approved by	: Herbert
TITLE: 40.0 x 5.0 x 6.0 (mm) LTE Full-Band Ceramic		DOCUMENT	H2UE3P1D2G0100	REV.
Specification	na (CC40D9) Engineering n	NO.	H20E3P1D2G0100	G
			PAGE 12 O	F 16



- d. (1) Weight: 1 pcs / 4.0g typ 1 Reel / 3.1Kg typ
 - (2) Quantity/Reel: 600 pcs/Reel
 - (3) Plastic tape: Clear Non Anti-static Polystyrene



- e. (1) Weight: 2 Reel /1 carton 6.8Kg typ
 - (2) 2 Reel / 1200 pcs in one carton
 - (3) Carton Dimensions 340*350*200 mm



12. Operating & Storage Conditions

- 12-1. Operating
 - (1) Maximum Input Power: 2 W
 - (2) Operating Temperature: -40 $^\circ\!\mathrm{C}$ to 85 $^\circ\!\mathrm{C}$
 - (3) Relative Humidity: 10% to 70%
- 12-2. Storage (sealed)
 - (1) Storage Temperature: -5°C to 40°C
 - (2) Relative Humidity: 20% to 70%
 - (3) Shelf Life: 1 year

12-3. Storage (unsealed) Meet the criteria of <u>J-STD-033 MSL2a</u>

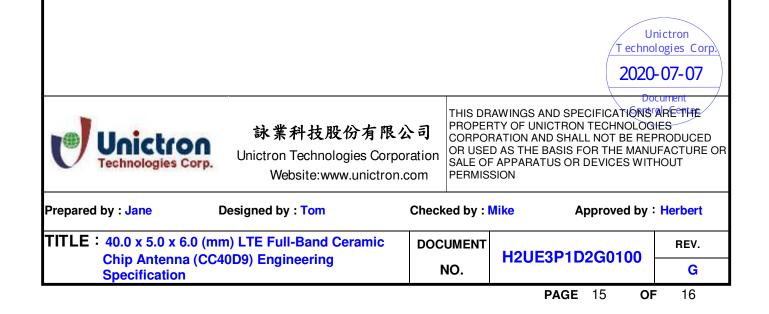
- 12-4. Storage (After mounted on customer's PCB with SMT process)
 - (1) Storage Temperature: -40 $^\circ\!\mathrm{C}$ to 85 $^\circ\!\mathrm{C}$
 - (2) Relative Humidity: 10% to 70%

13. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.



14. Reliability Test

T	T . O			D	
Test Items	Test Condi			Result	
1. Solderability	*Solder Temperature : 250 ± 5°C *Test time: 2 +/- 0.5 sec *With solder paste			Pass	
2. Temperature cycling	-40°C/ 30min~90°C /30m	in			
	Total <u>10</u> cycles			Pass	
	* Specimens are kept at standard				
	measurement environment for more than 24		n 24		
	hours before testing.				
3. Damp heat	*Humidity:90~95%				
	*Temperature: 85°C				
		Pass			
	* Specimens are kept at s	standard			
	n 24				
	hours before testing				
4. Adhesive strength of	dhesive strength of * Resistance to bending of printed-circuit				
terminal electrodes	rminal electrodes test board(110x40x1.6mm)			Pass	
	* Applied force: 5Kgf ;			Pass	
	* Duration : 10±1sec				
5. High temperature exposure	*Temperature : 90°C				
	*Test duration : 240 hours			Pass	
	* Specimens are kept at standard				
	measurement environment		n 24		
	hours before testing.				
6. Low temperature exposure	*Temperature : -40°C				
	*Test duration : 240 hour	S			
	* Specimens are kept at standard			Pass	
	measurement environment	n 24			
	hours before testing.				
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Prepared by : Jane Designed by : Tom Checked by : Mike Approved by : Herber					
TITLE: 40.0 x 5.0 x 6.0 (mm) L		DOCUMENT		211E3D1D2C0100	
Chip Antenna (CC40D Specification	<i>a)</i> ⊏ngineering	NO.	NO. H2UE3P1D2G0100		G
		1	PAGE	16 OF	16